



Material Content Data Sheet



Sales Product Name				IPD60R385CP		Issued		27. September 2017	
MA#				MA000909400					
Package				PG-TO252-3-341		Weight*		383.98 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	5.064	1.32	1.32	13189	13189	
leadframe	non noble metal	iron	7439-89-6	0.248	0.06		647		
	inorganic material	phosphorus	7723-14-0	0.075	0.02		194		
	non noble metal	copper	7440-50-8	248.124	64.62	64.70	646184	647025	
wire	non noble metal	aluminium	7429-90-5	4.420	1.15	1.15	11511	11511	
encapsulation	inorganic material	antimonytrioxide	1309-64-4	1.648	0.43		4293		
	plastics	brominated resin	-	1.766	0.46		4599		
	organic material	carbon black	1333-86-4	1.884	0.49		4906		
	plastics	epoxy resin	-	15.894	4.14		41392		
	inorganic material	silicondioxide	60676-86-0	96.541	25.14	30.66	251419	306609	
leadfinish	non noble metal	tin	7440-31-5	3.787	0.99	0.99	9862	9862	
plating	non noble metal	nickel	7440-02-0	0.515	0.13	0.13	1342	1342	
solder	noble metal	silver	7440-22-4	0.100	0.03		262		
	non noble metal	tin	7440-31-5	0.080	0.02		209		
	non noble metal	lead	7439-92-1	3.836	1.00	1.05	9991	10462	
*deviation	< 10%			Sum in total:		100.00		1000000	

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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